

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
ZHONGPING CAI	08/18/2014
JINGYI XIONG	08/18/2014
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	KLA-TENCOR CORPORATION
<b>Street Address:</b>	ONE TECHNOLOGY DRIVE
<b>City:</b>	MILPITAS
<b>State/Country:</b>	CALIFORNIA
<b>Postal Code:</b>	95035
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	14463225
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(402)496-0333
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	402.496.0300
<b>Email:</b>	file@suiter.com
<b>Correspondent Name:</b>	SUITER SWANTZ/KLA JOINT CUSTOMER NUMBER
<b>Address Line 1:</b>	14301 FNB PARKWAY
<b>Address Line 2:</b>	SUITE 220
<b>Address Line 4:</b>	OMAHA, NEBRASKA 68154-5299
<b>ATTORNEY DOCKET NUMBER:</b>	KLA P4243
<b>NAME OF SUBMITTER:</b>	MATTHEW A. POULSEN
<b>SIGNATURE:</b>	/matthew a poulsen/
<b>DATE SIGNED:</b>	08/19/2014
<b>Total Attachments: 4</b>	
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Please return signed/Recorded to:

CUSTOMER No. 78238  
Sean Patrick Suiter  
SUITER \* SWANTZ PC LLO  
14301 FNB Parkway, Suite 220  
Omaha, NE 68154-5299

ASSIGNMENT OF U.S. PATENT APPLICATION  
(sole or joint inventor(s))

WHEREAS, the undersigned, to wit:

- 1) Zhongping Cai
- 2) Jingyi Xiong

(hereinafter collectively ASSIGNOR), have made application for United States Letters Patent

(a)   X   which was executed and is being filed herewith in the United States Patent and Trademark Office, titled METHOD AND SYSTEM FOR HIGH SPEED HEIGHT CONTROL OF A SUBSTRATE SURFACE WITHIN A WAFER INSPECTION SYSTEM.

(b) \_\_\_\_\_ which was filed on \_\_\_\_\_ and titled \_\_\_\_\_

(c) \_\_\_\_\_ which was filed on \_\_\_\_\_ and known as Appln. No. \_\_\_\_\_, titled \_\_\_\_\_

AND WHEREAS, KLA-Tencor Corporation (hereinafter ASSIGNEE), organized and existing under the laws of Delaware, and having its principal place of business at One Technology Drive, Milpitas, CA, 95035, is desirous of acquiring our entire right, title and interest in and to the invention, and in and to the said application and any Patent that may issue thereon;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, ASSIGNOR does hereby sell, assign and transfer unto ASSIGNEE, its successors, assigns and legal representatives its entire right, title and interest in and to said invention and in and to said application and all patents which may be granted therefore, and all divisions, reissues, substitutions, continuations, continuations-in-part and extensions thereof; and ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks to issue all patents for said

invention, or patents resulting therefrom, insofar as ASSIGNOR's interest is concerned, to the said ASSIGNEE of ASSIGNOR's entire right, title and interest.

ASSIGNOR also hereby sells and assigns to said ASSIGNEE, its successors, assigns and legal representatives the full and exclusive rights, title and interest to the invention disclosed in said application throughout the world, including the right to file applications and obtain patents, utility models, industrial models and designs for said invention in its own name throughout the world including all rights of priority, all rights to publish cautionary notices reserving ownership of said invention and all rights to register said invention in appropriate registries; and

ASSIGNOR further agrees to execute any and all powers of attorney, applications, assignments, declarations, affidavits, and any other papers in connection therewith necessary to perfect such rights, title and interest in ASSIGNEE, its successors, assigns and legal representatives.

ASSIGNOR hereby further agrees to communicate with said ASSIGNEE, or its successors, assigns and legal representatives, any facts known to us respecting any improvements; and, at the expense of said ASSIGNEE, to testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, continuation-in-part, reissue and substitute applications, make all lawful oaths, and generally do everything possible to vest title in said ASSIGNEE and to aid said ASSIGNEE, its successors, assigns and legal representatives to obtain and enforce proper protection for said invention in all countries.

ASSIGNOR hereby grant(s) the firm of SUITER • SWANTZ PC LLO or its agents the power to insert on this assignment any further identification, including but not limited to application number(s) and filing dates, which may be necessary or desirable in order to comply with any rule or request of the United States Patent and Trademark office for the purposes of recording this document.

First named inventor

Name: \_\_\_\_\_

*[Handwritten Signature]*

Zhongping Cai

Date: \_\_\_\_\_

*8/18/2014*

Witness Signature: \_\_\_\_\_

*[Handwritten Signature]*

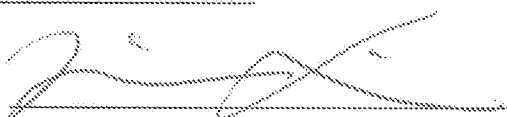
Witness Printed Name: \_\_\_\_\_

*Chunhai Wang*

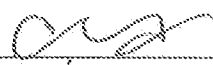
Witness Address: \_\_\_\_\_

*5026 Blackbird Way  
Plausmon CA 94566*

Second named inventor

Name:   
Jingyi Xiong

Date: 8/18/2014

Witness Signature:   
Witness Printed Name: Chunhui Wang  
Witness Address: 506 Blackbird Way  
Pleasanton CA 94566